

# DATA SHEET

# NEC

## NPN SILICON RF TRANSISTOR 2SC5507

### NPN SILICON RF TRANSISTOR FOR LOW CURRENT, LOW-NOISE, HIGH-GAIN AMPLIFICATION FLAT-LEAD 4-PIN THIN-TYPE SUPER MINIMOLD (M04)

#### FEATURES

- Low noise and high gain with low collector current
- $NF = 1.2 \text{ dB TYP.}$ ,  $G_a = 16 \text{ dB TYP.}$  @  $V_{CE} = 2 \text{ V}$ ,  $I_c = 2 \text{ mA}$ ,  $f = 2 \text{ GHz}$
- Maximum stable power gain:  $MSG = 22 \text{ dB TYP.}$  @  $V_{CE} = 2 \text{ V}$ ,  $I_c = 5 \text{ mA}$ ,  $f = 2 \text{ GHz}$
- $f_T = 25 \text{ GHz}$  technology adopted
- Flat-lead 4-pin thin-type super minimold (M04) package

#### ORDERING INFORMATION

Part Number	Quantity	Supplying Form
2SC5507	50 pcs (Non reel)	• 8 mm wide embossed taping
2SC5507-T2	3 kpcs/reel	• Pin 1 (Emitter), Pin 2 (Collector) face the perforation side of the tape

**Remark** To order evaluation samples, contact your nearby sales office.  
The unit sample quantity is 50 pcs.

#### ABSOLUTE MAXIMUM RATINGS ( $T_A = +25^\circ\text{C}$ )

Parameter	Symbol	Ratings	Unit
Collector to Base Voltage	$V_{CBO}$	15	V
Collector to Emitter Voltage	$V_{CEO}$	3.3	V
Emitter to Base Voltage	$V_{EBO}$	1.5	V
Collector Current	$I_c$	12	mA
Total Power Dissipation	$P_{tot}^{\text{Note}}$	39	mW
Junction Temperature	$T_j$	150	$^\circ\text{C}$
Storage Temperature	$T_{stg}$	-65 to +150	$^\circ\text{C}$

**Note** Free Air

**Caution** Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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Not all devices/types available in every country. Please check with local NEC Compound Semiconductor Devices representative for availability and additional information.

**THERMAL RESISTANCE**

Parameter	Symbol	Ratings	Unit
Junction to Case Resistance	$R_{th\ j-c}$	240	°C/W
Junction to Ambient Resistance	$R_{th\ j-a}$	650	°C/W

**ELECTRICAL CHARACTERISTICS (TA = +25°C)**

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
DC Characteristics						
Collector Cut-off Current	$I_{cBO}$	$V_{CB} = 5\text{ V}, I_E = 0\text{ mA}$	–	–	100	nA
Emitter Cut-off Current	$I_{EBO}$	$V_{EB} = 1\text{ V}, I_C = 0\text{ mA}$	–	–	100	nA
DC Current Gain	$h_{FE}^{Note\ 1}$	$V_{CE} = 2\text{ V}, I_C = 5\text{ mA}$	50	70	100	–
RF Characteristics						
Gain Bandwidth Product	$f_T$	$V_{CE} = 3\text{ V}, I_C = 10\text{ mA}, f = 2\text{ GHz}$	20	25	–	GHz
Insertion Power Gain	$ S_{21e} ^2$	$V_{CE} = 2\text{ V}, I_C = 5\text{ mA}, f = 2\text{ GHz}$	14	17	–	dB
Noise Figure	NF	$V_{CE} = 2\text{ V}, I_C = 2\text{ mA}, f = 2\text{ GHz}, Z_S = Z_{opt}$	–	1.2	1.5	dB
Reverse Transfer Capacitance	$C_{re}^{Note\ 2}$	$V_{CB} = 2\text{ V}, I_E = 0\text{ mA}, f = 1\text{ MHz}$	–	0.08	0.12	pF
Maximum Stable Power Gain	$MSG^{Note\ 3}$	$V_{CE} = 2\text{ V}, I_C = 5\text{ mA}, f = 2\text{ GHz}$	–	22	–	dB
Gain 1 dB Compression Output Power	$P_{O(1\text{ dB})}$	$V_{CE} = 2\text{ V}, I_C = 5\text{ mA}^{Note\ 4}, f = 2\text{ GHz}$	–	5	–	dBm
3rd Order Intermodulation Distortion Output Intercept Point	$OIP_3$	$V_{CE} = 2\text{ V}, I_C = 5\text{ mA}^{Note\ 4}, f = 2\text{ GHz}$	–	15	–	dBm

**Notes 1.** Pulse measurement:  $PW \leq 350\ \mu s$ , Duty Cycle  $\leq 2\%$

**2.** Collector to base capacitance when the emitter grounded

**3.**  $MSG = \left| \frac{S_{21}}{S_{12}} \right|$

**4.** Collector current when  $P_{O(1\text{ dB})}$  is output

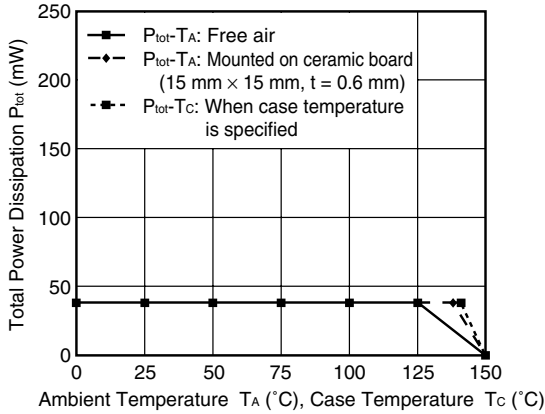
**hFE CLASSIFICATION**

Rank	FB
Marking	T78
hFE Value	50 to 100

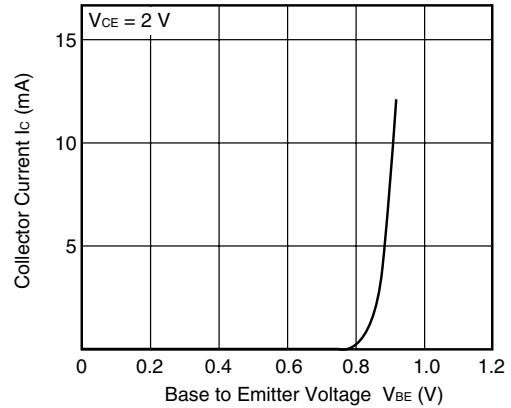
★ TYPICAL CHARACTERISTICS (T<sub>A</sub> = +25°C, unless otherwise specified)

Thermal/DC Characteristics

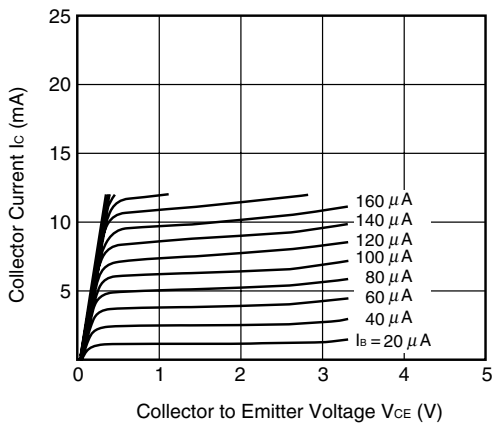
TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE, CASE TEMPERATURE



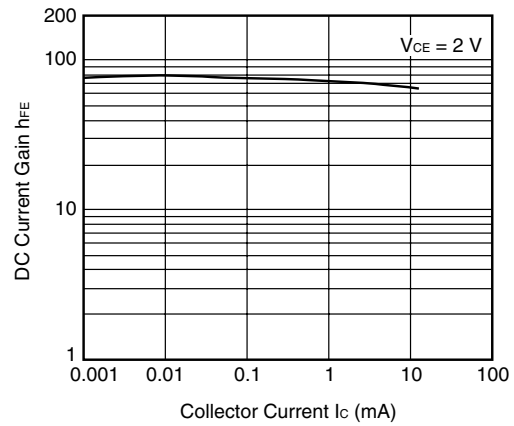
COLLECTOR CURRENT vs. BASE TO EMITTER VOLTAGE



COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE

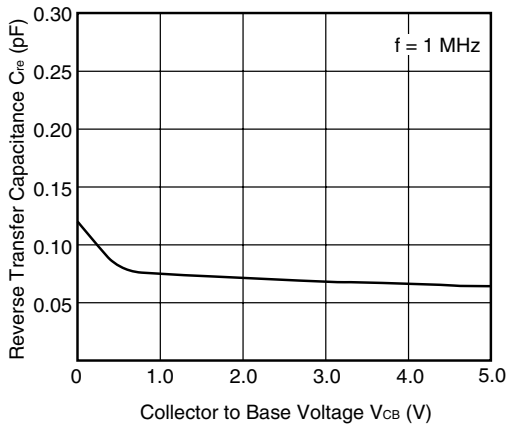


DC CURRENT GAIN vs. COLLECTOR CURRENT

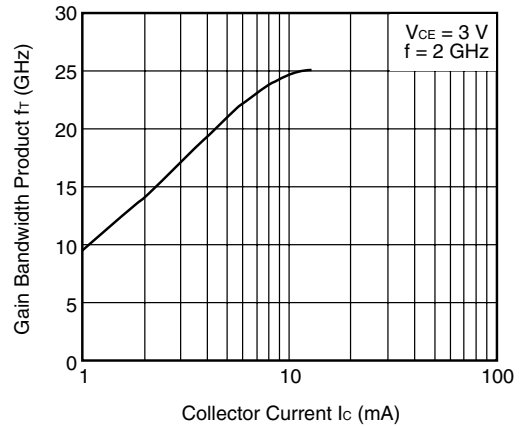


Capacitance/fr Characteristics

REVERSE TRANSFER CAPACITANCE vs. COLLECTOR TO BASE VOLTAGE

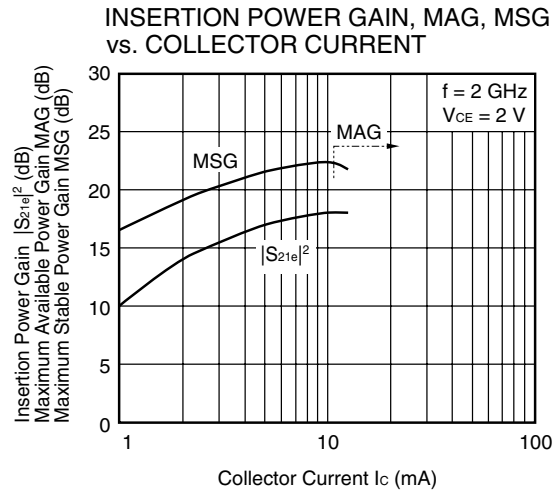
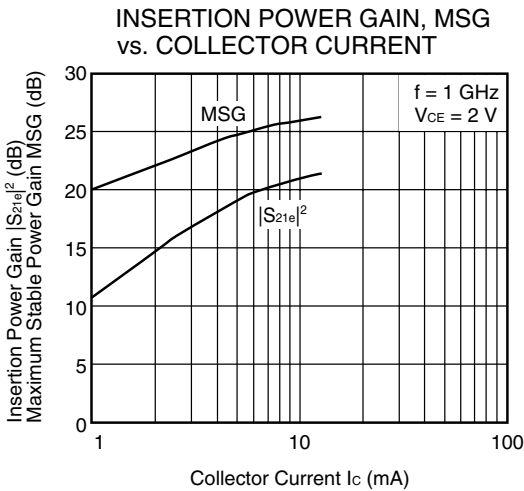
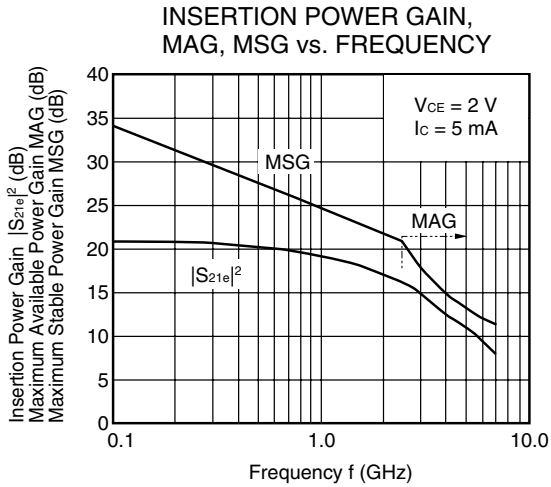


GAIN BANDWIDTH PRODUCT vs. COLLECTOR CURRENT

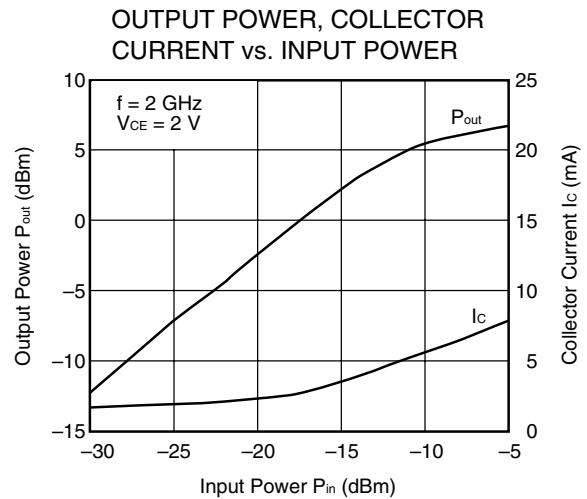
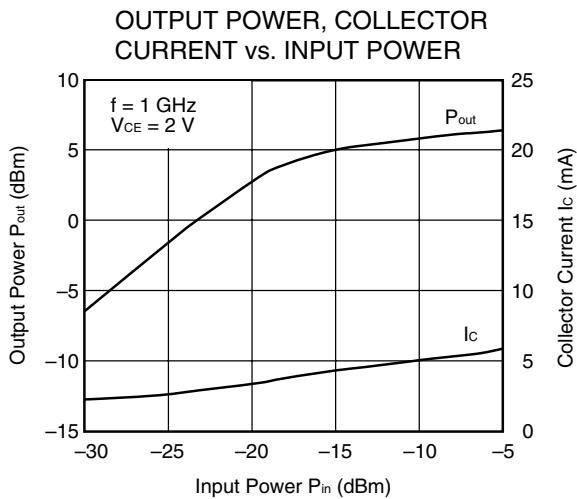


**Remark** The graphs indicate nominal characteristics.

Gain Characteristics

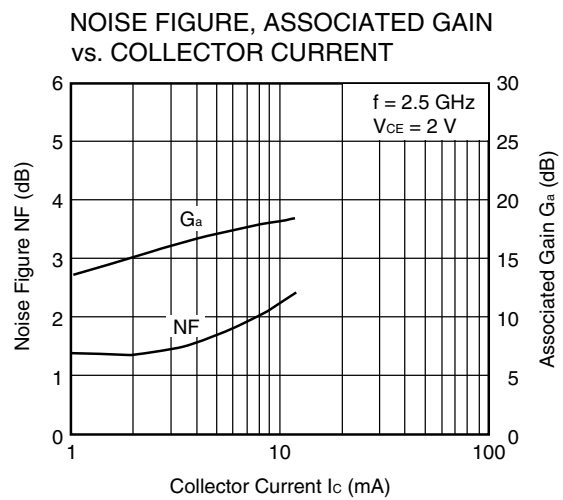
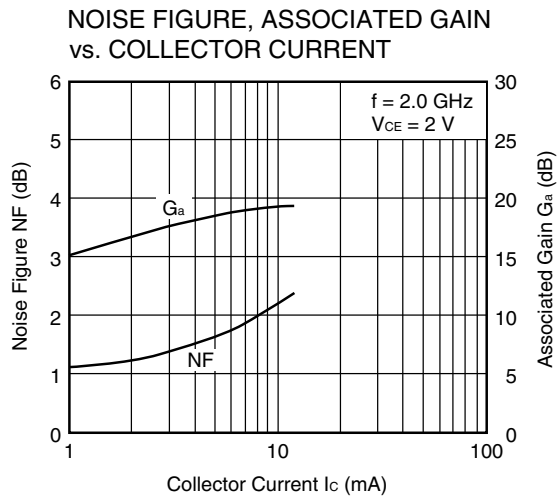
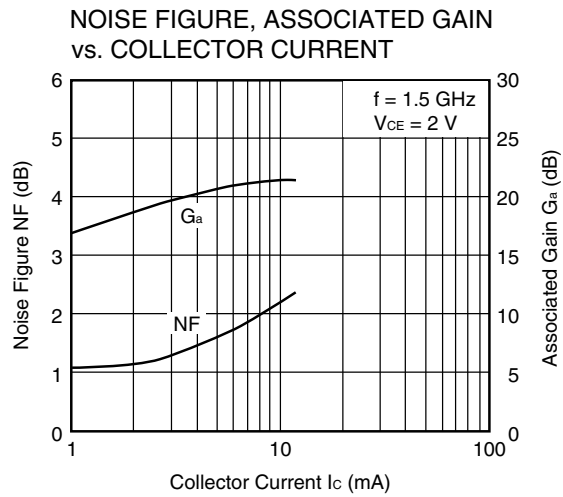
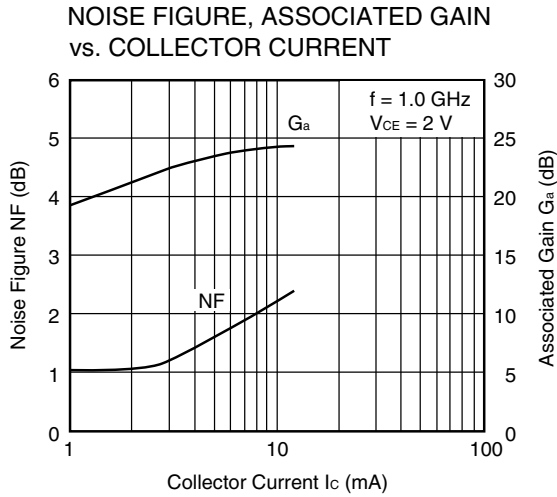


Output Characteristics



**Remark** The graphs indicate nominal characteristics.

**Noise Characteristics**



**Remark** The graphs indicate nominal characteristics.

★ **S-PARAMETERS**

S-parameters/Noise parameters are provided on the NEC Compound Semiconductor Devices Web site in a form (S2P) that enables direct import to a microwave circuit simulator without keyboard input.

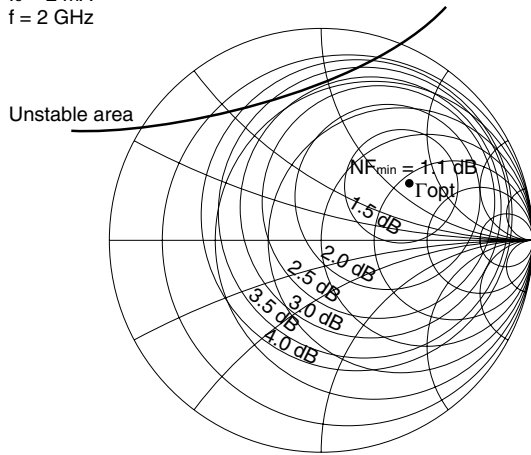
Click here to download S-parameters.

[RF and Microwave] → [Device Parameters]

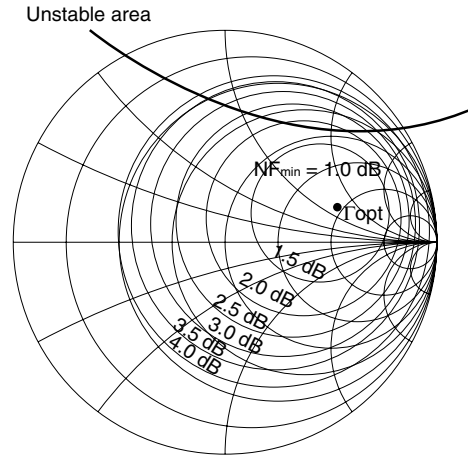
URL <http://www.ncsd.necel.com/>

EQUAL NF CIRCLE

$V_{CE} = 2\text{ V}$   
 $I_C = 2\text{ mA}$   
 $f = 2\text{ GHz}$



$V_{CE} = 2\text{ V}$   
 $I_C = 2\text{ mA}$   
 $f = 1\text{ GHz}$



**NOISE PARAMETERS**

V<sub>CE</sub> = 2 V, I<sub>c</sub> = 2 mA

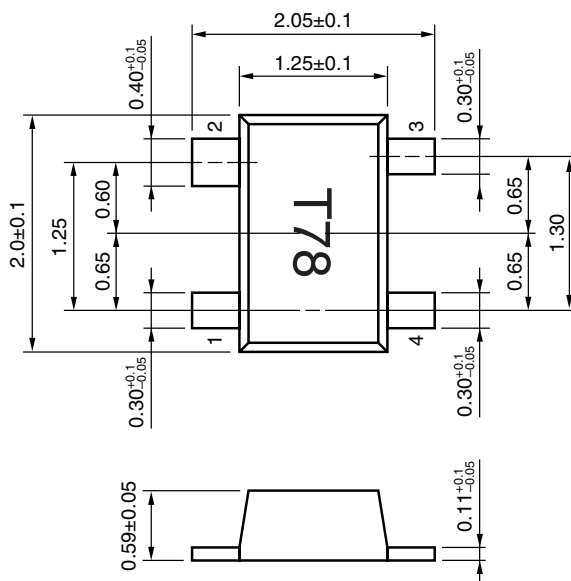
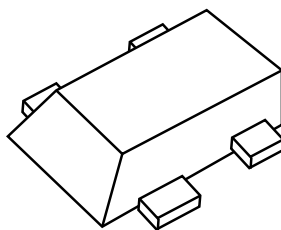
f (GHz)	NF <sub>min</sub> (dB)	G <sub>a</sub> (dB)	Γ <sub>opt</sub>		Rn/50
			MAG.	ANG.	
0.8	0.93	22.9	0.54	13.3	0.47
0.9	0.95	22.2	0.54	14.9	0.47
1.0	0.97	21.6	0.54	16.4	0.47
1.5	1.08	18.8	0.53	24.6	0.45
1.8	1.14	17.5	0.51	30.3	0.43
1.9	1.16	17.1	0.50	32.4	0.42
2.0	1.18	16.7	0.49	34.6	0.41
2.5	1.29	15.2	0.44	47.7	0.35

V<sub>CE</sub> = 2 V, I<sub>c</sub> = 5 mA

f (GHz)	NF <sub>min</sub> (dB)	G <sub>a</sub> (dB)	Γ <sub>opt</sub>		Rn/50
			MAG.	ANG.	
0.8	1.59	24.7	0.38	10.7	0.43
0.9	1.60	24.1	0.38	11.9	0.43
1.0	1.60	23.4	0.38	13.2	0.43
1.5	1.62	20.7	0.36	20.5	0.41
1.8	1.63	19.3	0.34	25.7	0.38
1.9	1.63	18.9	0.33	27.5	0.38
2.0	1.63	18.5	0.32	29.4	0.37
2.5	1.65	16.9	0.26	40.1	0.32

★ PACKAGE DIMENSIONS

FLAT-LEAD 4-PIN THIN-TYPE SUPER MINIMOLD (M04) PACKAGE (UNIT: mm)



**PIN CONNECTIONS**

1. Emitter
2. Collector
3. Emitter
4. Base



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